## QOCVO

## **SiC JFET Division**

**Is Now Part of** 

# Onsemi

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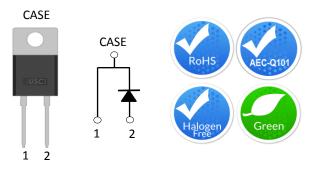
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Datasheet

#### Description

United Silicon Carbide, Inc. offers the 3<sup>rd</sup> generation of high performance SiC Merged-PiN-Schottky (MPS) diodes. With zero reverse recovery charge and 175°C maximum junction temperature, these diodes are ideally suited for high frequency and high efficiency power systems with minimum cooling requirements.



Part Number	Package	Marking
UJ3D06530TS	TO-220-2L	UJ3D06530TS

### Typical Applications

- Power converters
- Industrial motor drives
- Switching-mode power supplies
- Power factor correction modules

#### Features

- 175°C maximum operating junction temperature
- Easy paralleling
- Extremely fast switching not dependent on temperature
- No reverse or forward recovery
- Enhanced surge current capability, MPS structure
- Excellent thermal performance, Ag sintered
- 100% UIS tested
- AEC-Q101 qualified
- AECQ Qualified

#### **Maximum Ratings**

Parameter	Symbol	Test Conditions	Value	Units	
DC blocking voltage	V <sub>R</sub>		650	V	
Repetitive peak reverse voltage, T <sub>j</sub> =25°C	V <sub>RRM</sub>		650	V	
Surge peak reverse voltage	V <sub>RSM</sub>		650	V	
Maximum DC forward current	I <sub>F</sub>	T <sub>c</sub> = 140°C	30	А	
Non-repetitive forward surge current		T <sub>C</sub> = 25°C, t <sub>p</sub> = 10ms	165		
sine halfwave	I <sub>FSM</sub>	T <sub>c</sub> = 110°C, t <sub>p</sub> =10ms	150	A	
Repetitive forward surge current		T <sub>c</sub> = 25°C, t <sub>p</sub> = 10ms	107.2	А	
sine halfwave, D=0.1	I <sub>FRM</sub>	T <sub>c</sub> = 110°C, t <sub>p</sub> =10ms	66.1		
		T <sub>c</sub> = 25°C, t <sub>p</sub> =10μs	1250		
Non-repetitive peak forward current	I <sub>F,max</sub>	T <sub>c</sub> = 110°C, t <sub>p</sub> =10μs	1250	A	
i <sup>2</sup> t value	∫i <sup>2</sup> dt	T <sub>c</sub> = 25°C, t <sub>p</sub> =10ms	136	— A <sup>2</sup> s	
i t value	jiat	T <sub>c</sub> = 110°C, t <sub>p</sub> =10ms	112		
Devier dissignation	D	T <sub>C</sub> = 25°C	288.5	- w	
Power dissipation	P <sub>Tot</sub>	T <sub>C</sub> = 140°C	67.3		
Maximum junction temperature	T <sub>J,max</sub>		175	°C	
Operating and storage temperature	T <sub>J</sub> , T <sub>STG</sub>		-55 to 175	°C	
Soldering temperatures, wavesoldering only allowed at leads	T <sub>sold</sub>	1.6mm from case for 10s	260	°C	



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#### **Electrical Characteristics**

#### T<sub>J</sub> = +25°C unless otherwise specified

Parameter	Symbol	Test Conditions	Value			Units
			Min	Тур	Max	Units
	V <sub>F</sub>	I <sub>F</sub> = 30A, T <sub>J</sub> = 25°C	-	1.5	1.7	V
Forward voltage		I <sub>F</sub> = 30A, T <sub>J</sub> =150°C	-	1.77	2.10	
		I <sub>F</sub> = 30A, T <sub>J</sub> =175°C	-	1.85	2.25	
Reverse current	I <sub>R</sub>	V <sub>R</sub> =650V, T <sub>j</sub> =25°C	-	30	370	μА
		V <sub>R</sub> =650V, T <sub>J</sub> =175°C	-	390		
Total capacitive charge <sup>(1)</sup>	Q <sub>c</sub>	V <sub>R</sub> =400V		72		nC
		V <sub>R</sub> =1V, f=1MHz		990		pF
Total capacitance	С	V <sub>R</sub> =300V, f=1MHz		117		
		V <sub>R</sub> =600V, f=1MHz		101		
Capacitance stored energy	E <sub>c</sub>	V <sub>R</sub> =400V		10.5		μ

(1)  $Q_c$  is independent on  $T_{j'}$ ,  $di_F/dt$ , and  $I_F$  as shown in the application note USCi\_AN0011.

#### **Thermal characteristics**

Parameter	symbol	Test Conditions	Value			Units
			Min	Тур	Max	Units
Thermal resistance, junction - case	$R_{\theta JC}$			0.4	0.52	°C/W

#### **Typical Performance**

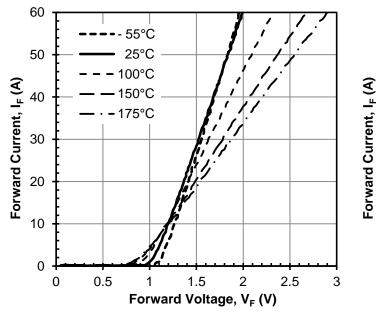


Figure 1 Typical forward characteristics

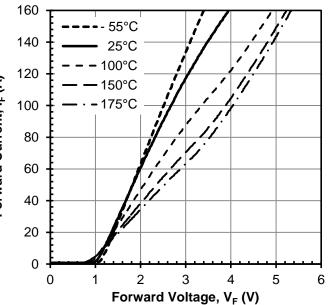


Figure 2 Typical forward characteristics in surge current



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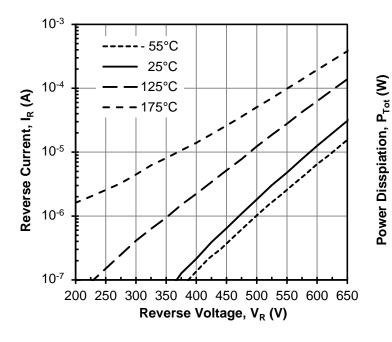




Figure 4 Power dissipation

T<sub>c</sub> (°C)

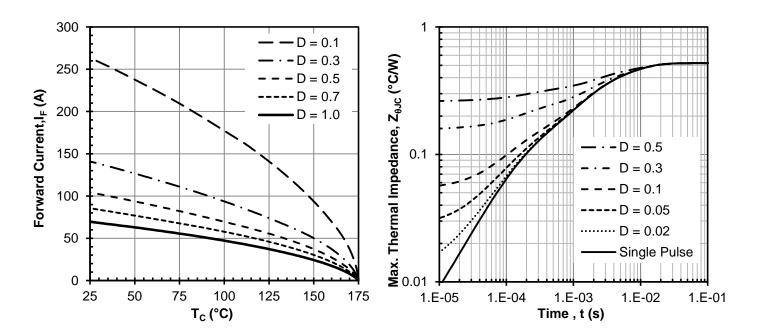


Figure 5 Diode forward current

Figure 6 Maximum transient thermal impedance



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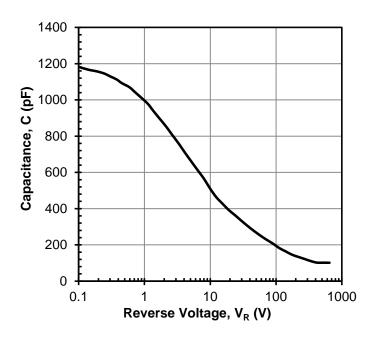


Figure 7 Capacitance vs. reverse voltage at 1MHz

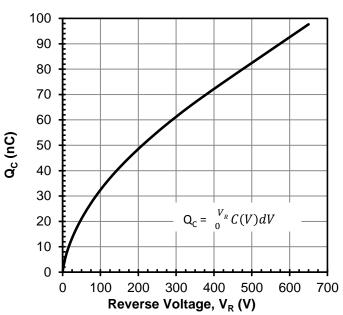


Figure 8 Typical capacitive charge vs. reverse voltage

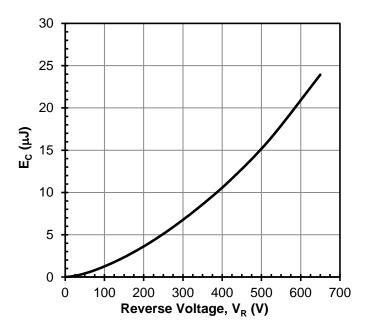


Figure 9 Typical capacitance stored energy vs. reverse voltage



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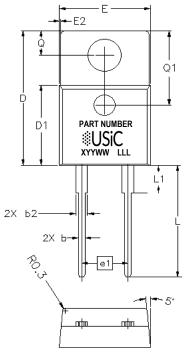
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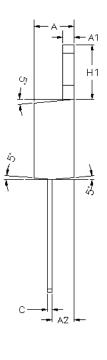
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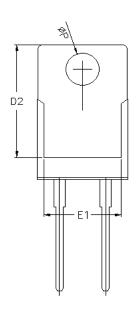


## TO-220-2L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

#### PACKAGE OUTLINE





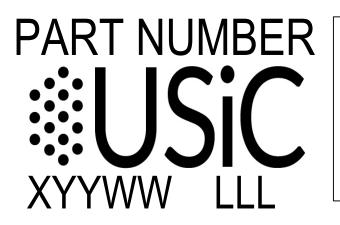


DIM	INC	HES	MILLIN	<b>IETERS</b>
	MIN	MAX	MIN	MAX
А	0.140	0.190	3.56	4.83
A1	0.020	0.055	0.51	1.40
A2	0.080	0.115	2.03	2.92
b	0.015	0.040	0.38	1.02
b2	0.040	0.070	1.02	1.78
С	0.014	0.030	0.36	0.76
D	0.560	0.650	14.22	16.51
D1	0.330	0.370	8.38	9.40
D2	0.480	0.517	12.19	13.13
E	0.380	0.420	9.65	10.67
e1	0.20	0.200 BSC		BSC
E1	0.270	0.350	6.86	8.89
E2	-	0.030		0.76
L	0.495	0.580	12.57	14.73
L1	-	0.250	-	6.35
ØP	0.139	0.161	3.53	4.09
Н	0.230	0.270	5.84	6.86
Q	0.100	0.135	2.54	3.43
Q1	0.330	0.340	8.38	8.64



TO-220-2L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

#### PART MARKING



PART NUMBER = REFER TO DS\_PN DECODER FOR DETAILS

X = ASSEMBLY SITE YY = YEAR WW = WORK WEEK LLL = LOT ID

#### PACKING TYPE

ANTI-STATIC TUBE

**QUANTITY /TUBE : 50 UNITS** 

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